



State-of-the-Art of Cybersecurity

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Message from the Guest Editors

This Special Issue focuses on emerging topics in cybersecurity that support a wide range of applications with emphasis placed on the research directions of a) cyber resilience, b) risk and attack surface exposure analysis, c) security management processes and legal and regulatory ramifications in modern cyberinfrastructures and d) AI-enabled cyber threats and proactive defences.

This Special Issue is dedicated to publishing cutting-edge research addressing the various research trends and challenges in cybersecurity and provide insights to researchers and practitioners in the field.





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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